

Call for Application for Sponsorship Asian Conference on Tunnelling and Trenchless Technology (ACTT) 2025, in Kuala Lumpur, Malaysia 10–12 September 2025

Introduction

The Asian Conference on Tunnelling and Trenchless Technology (ACTT2025), will be held in Kuala Lumpur, Malaysia from 10-12 September 2025. The purpose of the conference is to continue the tradition of promoting knowledge exchange, innovation, and technological advancements in tunnelling and trenchless construction across Asia. The conference aims to bring together professionals, academics, industry leaders, and stakeholders from various sectors to discuss challenges, share experiences, and foster collaboration. It will provide a platform for showcasing cutting- edge research, technology, and solutions that contribute to the sustainable development of underground space.

Topics include:- 1) Sustainability and green tunnelling practices, 2) Digital transformation and emerging technologies, and 3) Innovative and resilient infrastructure for a post- pandemic world. Details for this

Event shall be referred to the website:

<https://www.myiem.org.my/events/eventregistration.aspx?id=28024>

Invitation to Apply for Sponsorship

HKIE GDC is considering to sponsor up to 2 engineers to join this Event. Subsidy on registration fee up to HK\$5,000 will be offered to the successful applicants individually. To qualify, applicants shall satisfy the following basic criteria:

- i. Be a member of the Hong Kong Institution of Engineers, of whatever class;
- ii. Submit your current curriculum vitae;
- iii. Prepare a written report on the Event.

The successful applicants may be invited by the GDC to share their experience of this Event which will be held in Hong Kong after the Event.

The applications will be assessed by the GDC based on the relevancy of this Event to their career development. The successful applicants will be notified no later than 8th August 2025. All applications or enquiries shall be submitted by 1st August 2025 to Ir Ray CHAN, Tel: 9687 3131, email: ray.chan@aurecongroup.com.

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Application for Sponsorship

Personal Particulars	
Name: _____ (in English)	_____ (in Chinese)
HKIE/HKGES Membership No:	HKIE/HKGES Membership Class:
Organization:	Capacity:
Correspondence Address:	
Tel:	Mobile:
Fax:	Email:

Academic/Professional Qualifications
Academic Qualifications:
Professional Qualifications:

Working Experience		
Name of Organisation:	Capacity:	Period:

Record of Services to HKIE / HKGES and Other Organizations		
Name of board/committee:	Capacity:	Period:

The personal data provided by means of this curriculum vitae form will be used as reference for the Institution to assess the merit of sponsoring the application.
In accordance with Section 18 and 22 and Principle 6 of Schedule 1 of the Personal Data (Privacy) Ordinance, you have the rights to request access to and request the correction of the data provided.